SN54LS696, SN54LS697, SN54LS699, SN74LS696, SN74LS697, SN74LS699 SYNCHRONOUS UP/DOWN COUNTERS WITH OUTPUT REGISTERS AND MULTIPLEXED 3-STATE OUTPUTS SDLS199 D2424, JANUARY 1981-REVISED MARCH 1988

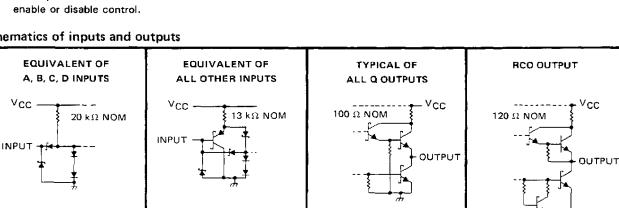
- **4-Bit Counters/Registers**
- Multiplexed Outputs for Counter or Latched Data
- **3-State Outputs Drive Bus Lines Directly**
- 'LS696 . . Decade Counter. Direct Clear 'LS697 . . Binary Counter, Direct Clear 'LS699 . . Binary Counter, Synchronous Clear

description

These low-power Schottky LSI devices incorporate synchronous up/down counters, four-bit D-type registers, and quadruple two-line to one-line multiplexers with three state outputs in a single 20-pin package. The up/down counters are programmable from the data inputs and feature enable \overline{P} and enable \overline{T} and a ripple-carry output for easy expansion. The register/counter select input R/\overline{C} , selects the counter when low and the register when high for the three-state outputs, QA, QB, QC, and QD. These outputs are rated at 12 and 24 milliamperes (54LS/74LS) for good bus driving performance.

Both the counter CCK and register clock RCK are positiveedge triggered. The counter clear CCLR is active low and is asynchronous on the 'LS696 and 'LS697, synchronous on the 'LS699. Loading of the counter is accomplished when LOAD is taken low and a positive transition occurs on the counter clock CCK.

Expansion is easily accomplished by connecting RCO of the first stage to ENT of the second stage, etc. All ENP inputs can be tied common and used as a master

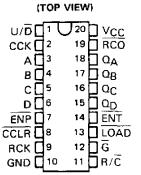


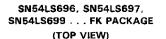
schematics of inputs and outputs

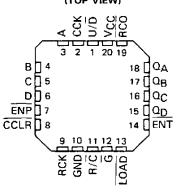
PRODUCTION DATA documents contain information

current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters. IEXAS INSTRUMENTS POST OFFICE BOX 655012 + DALLAS, TEXAS 75265

SN54LS696, SN54LS697, SN54LS699 . . . J OR W PACKAGE SN74LS696, SN74LS697, SN74LS699 . . . DW OR N PACKAGE



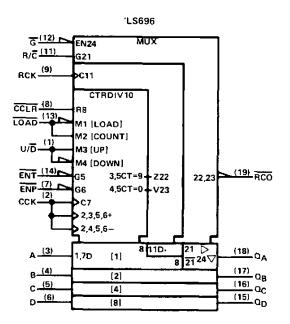


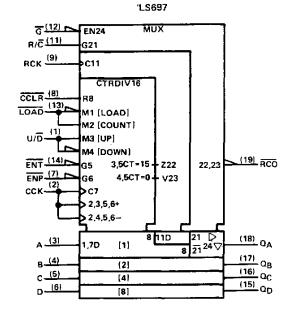


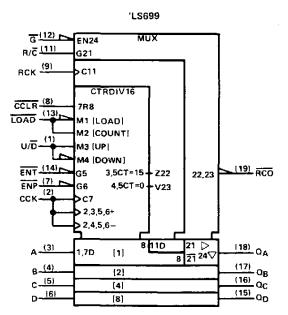
SN54LS696, SN54LS697, SN54LS699; SN74LS696, SN74LS697, SN74LS699 SYNCHRONOUS UP/DOWN COUNTERS WITH OUTPUT REGISTERS AND MULTIPLEXED 3-STATE OUTPUTS

logic symbols[†]

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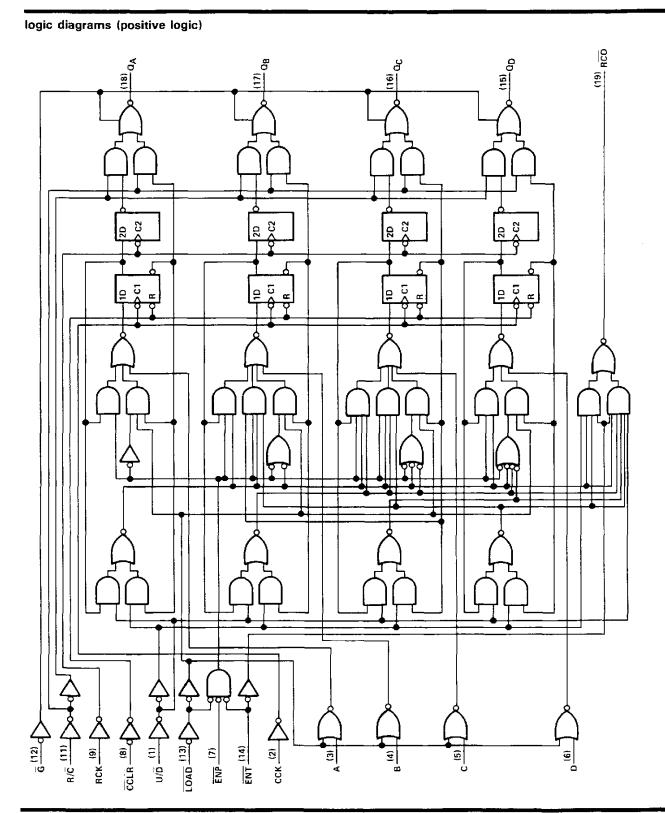




[†]These symbols are in accordance with ANSI/IEEE Std. 91-1984 and IEC Publication 617-12.



SN54LS696, SN74LS696 Synchronous UP/down Counters With Output registers and multiplexed 3-state outputs



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TEXAS A

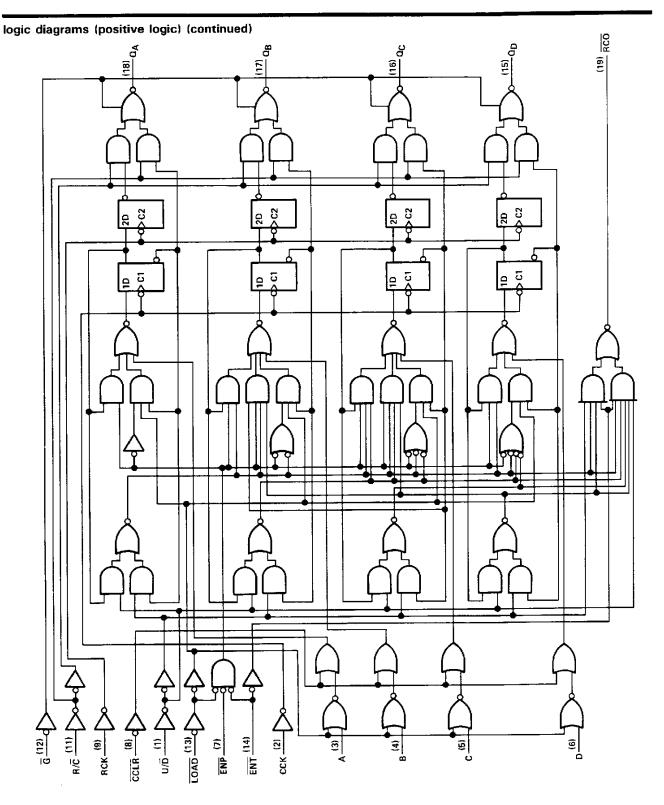
SN54LS697, SN74LS697 SYNCHRONOUS UP/DOWN COUNTERS WITH OUTPUT REGISTERS AND MULTIPLEXED 3-STATE OUTPUTS

(19) RCO (18) _A 8 မ္မ 9 3 16) (15) 0 0 3 20 20 20 3 20 ຂ 2 e S 5 <u>0</u> 0 0 0 le _è ≙ ĊC, œ Æ œ RCK (9) 1) <u>1</u> <u>1</u> <u>0</u> LOAD (13) G (12) ENP (7) ENT (14) CCK (2) c 15) Ξ Ē 9 < ά α ò

logic diagrams (positive logic) (continued)



SN54LS698, SN74LS698 SYNCHRONOUS UP/DOWN COUNTERS WITH OUTPUT REGISTERS AND MULTIPLEXED 3-STATE OUTPUTS

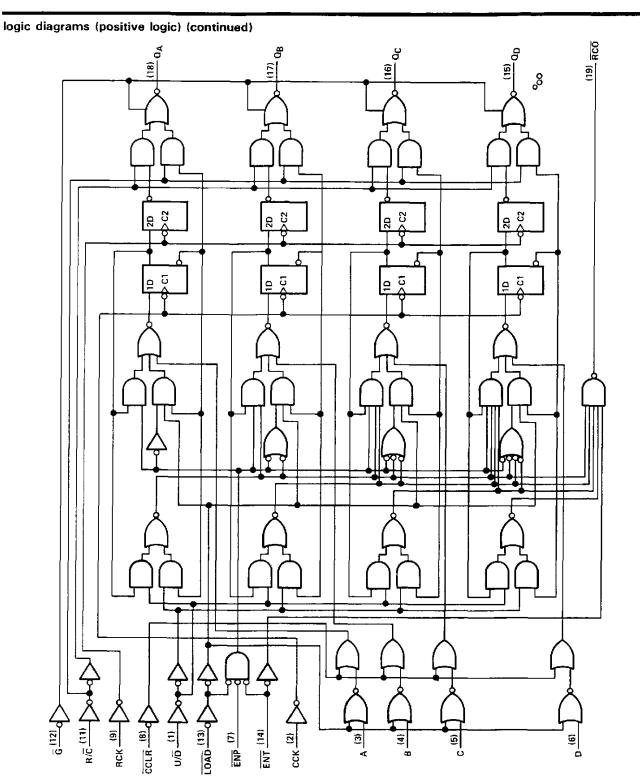


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SN54LS699, SN74LS699 SYNCHRONOUS UP/DOWN COUNTERS WITH OUTPUT REGISTERS AND MULTIPLEXED 3-STATE OUTPUTS

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TEXAS A

SN54LS696, SN54LS697, SN54LS699, SN74LS696, SN74LS697, SN74LS699 Synchronous UP/Down Counters With Output registers and multiplexed 3-state outputs

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V _{CC} (see Note 1)
Input voltage
Off-state output voltage
Operating free-air temperature range: SN54LS696, SN54LS697, SN54LS69955°C to 125°C
SN74LS696, SN74LS697, SN74LS699 0°C to 70°C
Storage temperature range65°C to 150°C

NOTE 1: Voltage values are with respect to network ground terminals.

recommended operating conditions

				SN54LS	i'	-	SN74LS	5'		
			MIN	NOM	MAX	MIN	NOM	MAX	UNI.	
Vcc_	Supply voltage		4.5	5	5.5	4.75	5	5.25	V	
юн	High-level output current	Q			- 1			- 2.6		
•UH		RCO			- 0.4			- 0.4	mΑ	
1	Low-level output current				12	i —		24		
		RCO			4			8	- mA	
f.,	Clock frequency	ССК	0		20	0		20		
CIOCK		RCK	0		20	0		20	MHz	
	Pulse duration	CCK high or low	25			25	_			
tw		RCK high or low	25			25			ns	
		'LS696, 'LS697 CCLR low	20			20				
		A thru D	30			30				
		ENP or ENT	30			30				
tsu	Setup time	LOAD	30			30				
	before CCK t	U/D	35			35	······		n\$	
		'LS696, 'LS697, CCLR inactive	25	· <u>-</u> · · · · ·		25				
		'LS699, CCLR	30			30				
tsu	Setup time CCK 1 before RCk	t (see Note 2)	30			30			ns	
^t h	Hold time		0			0			ns	
TA	Operating free-air temperature		- 55		125	0		70	°C	

NOTE 2: This set up time ensures the register will see stable data from the counter outputs. The clocks may be tied together in which case the register state will be one clock pulse behind the counter.



SN54LS696, SN54LS697, SN54LS699, SN74LS696, SN74LS697, SN74LS699 SYNCHRONOUS UP/DOWN COUNTERS WITH OUTPUT REGISTERS AND MULTIPLEXED 3-STATE OUTPUTS

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

			TERT CON		[SN54LS	•	SN74LS'			UNIT	
	PARAMETER		TEST CONDITIONS [†]			TYP [‡]	MAX	MIN	TYP [‡]	MAX		
⊻ін	High-level input voltage				2			2			V	
VIL	Low-level input voltage				ļ		0.7	j		0,8	V V	
۷ік	input clamp voltage		VCC=MIN, IJ=-18 mA				-1.5			-1.5	V	
		Απγ Ο	V _{CC} =MIN, V _{IH} =2 V,	IOH=-1 mA	2.4	3,1			-			
۷он	High-level output voltage	Any Q		IOH=2.6 mA				2.4	3.1		v	
		RCO	ViF=Alf wax	I _{OH} =-400 µA	2.5	3.2		2.7	3.2			
		Any Q		IOL=12 mA		0.25	0,4		0.25	0.4		
Vol	Low-level output voltage	Any Q	V _{CC} =MIN, V _{IH} =2 V,	I _{OL} =24 mA					0.35	0.5	- v	
VOL	Low-level on (put voltage	RCO	ViL≃ViL max	IOL=4 mA		0.25	0.4		0.25	0.4		
		RCO		IOL=8 mA					0.35	0.5		
IOZH	Off-state output current,	Anv Q	V _{CC} =MAX, G at 2 V,	Vo=27V	Γ		20			20	μA	
102H	high-level voltage applied		VCC MAX, Gatz V,	VU-2.7 V		_				20		
IOZL	Off-state output current,	Any Q	Vcc=MAX, G at 2 V.	Vo=0.4 V			-20			-20	μA	
	low-level voltage applied			•0 • •								
t _l	Input current at maxi-		Vcc=MAX, Vt=7 V				0,1			0.1	mA	
	mum input voltage											
ЧН	High-level input current		V _{CC} =MAX, V _I =2.7 V				20			20	μА	
կլ	Low-level input current	A thru D	V _{CC} =MAX, V₁=0,4 V		l		-0.4			-0.4	mA	
··· •		All others			L		-0.2			-0.2		
los	Short-circuit	Anγ Q	V _{CC} =MAX, V _O =0 V		30		-130	30		-130	mA	
-03	output current §	RCO		·	-20		-100	-20		-100		
ССН	Supply current, outputs h	igh	Vcc=MAX,	See Note 3		46	65		46	65		
ICCL	Supply current, outputs lo	wc	All outputs open	See Note 4	L	48	70		48	70	mΑ	
lccz	Supply current, outputs o	ff	·····	See Note 5		48	70		48	70		

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

⁴ All typical values are at $V_{CC} = 5 V$, $T_A = 25^{\circ}C$.

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 \S Only one output should be shorted at a time, and duration of the short-circuit should not exceed one second,

NOTES: 3, I_{CCH} is measured after two 4.5 V to 0 V to 4.5 V pulses have been applied to CCK and RCK while G is grounded and all other inputs are at 4.5 V.

I_{CCL} is measured after two 0 V to 4.5 V to 0 V pulses have been applied to CCK and RCK while all other inputs are grounded.
I_{CCZ} is measured after two 0 V to 4.5 V to 0 V pulses have been applied to CCK and RCK while G is at 4.5 V and all other inputs are grounded.

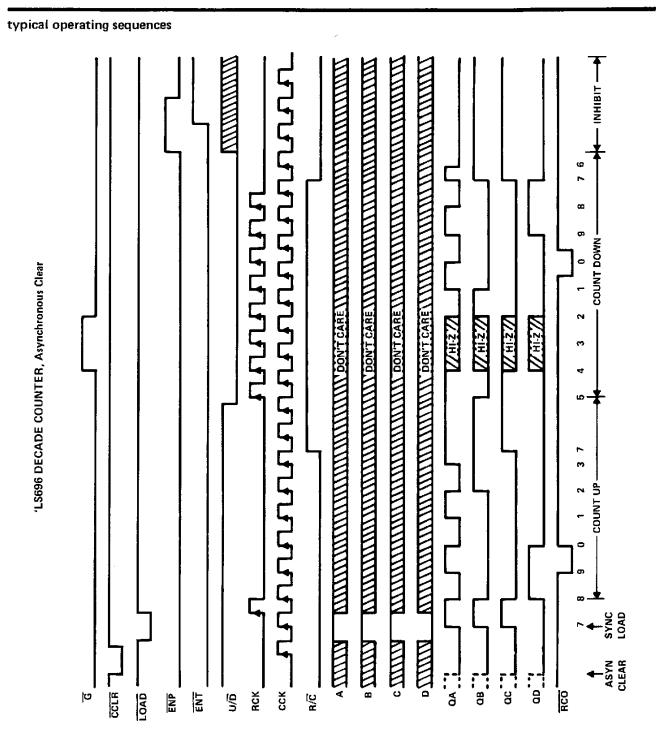
switching characteristics, $V_{CC} = 5 V$, $T_{A} = 25^{\circ}C$ (see note 6)

PARAMETER	FROM	то	TEST CONDITIONS	'LS6	96, 'L	S697		'LS699	à	
TANAMETER	(INPUT)	(OUTPUT)		MIN	TYP	TYP MAX		MIN TYP MAX		UNIT
^t PLH	CCKT	RCO			23	40	-	23	40	ns
^t PHL					23	40	-	23	40	ns
tPLH_	ËNT	RCO	$R_L = 2 k\Omega, C_L = 15 pF$		13	20		13	20	ns
tPHL	E141			_	13	20	-	13	20	ns
tPLH	CCKt	a		(12	20		12	20	ns
^t ₽HL		<u> </u>			17	25		17	25	ns
^t PLH	RCKT	0			12	20		12	20	ns
tPHL_					17	25		17	25	ns
^t PHL	CCLR↓	Q	$R_{L} = 667 \ \Omega, C_{L} = 45 \ pF$		23	40				ns
^t PLH	R/C	a		[16	25		16	25	ns
<u>tehl</u>	H/C				16	25		16	25	ПS
tPZH	<u>G</u> t	a		_	19	30		19	30	ns
tPZL					19	30		19	30	ns
tphz		a		1	17	30		17	30	ns
^t PLZ	J.		RL = 667 Ω, CL = 5 pF		17	30	_	17	30	ns

NOTE 6: Load circuits and voltage waveforms are shown in Section 1.



SN54LS696, SN74LS696 SYNCHRONOUS UP/DOWN COUNTERS WITH OUTPUT REGISTERS AND MULTIPLEXED 3 STATE OUTPUTS



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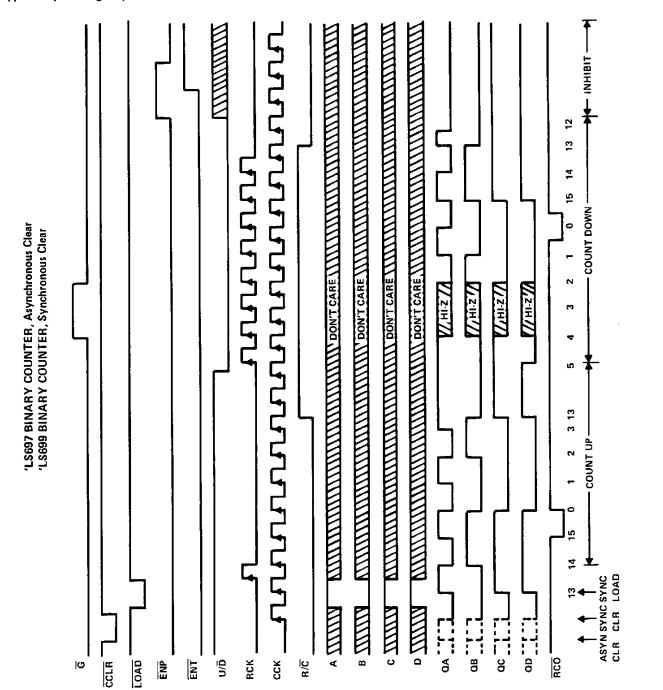


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SN54LS697, SN54LS699, SN74LS697, SN74LS699 Synchronous UP/Down Counters With Output Registers and Multiplexed 3-State Outputs

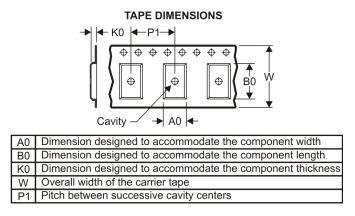
typical operating sequences (continued)

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TAPE AND REEL INFORMATION





QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



Device	Package Type	Package Drawing	Pins		Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74LS697NSR	SO	NS	20	2000	330.0	24.4	8.2	13.0	2.5	12.0	24.0	Q1



PACKAGE MATERIALS INFORMATION

5-Aug-2008



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74LS697NSR	SO	NS	20	2000	346.0	346.0	41.0



PACKAGING INFORMATION

Orderable Device	Status	Package Type	Package	Pins	Package	Eco Plan	Lead finish/	MSL Peak Temp	Op Temp (°C)	Device Marking	Samples
	(1)		Drawing		Qty	(2)	Ball material	(3)		(4/5)	
							(6)				
SN74LS697DW	ACTIVE	SOIC	DW	20	25	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS697	Samples
SN74LS697N	ACTIVE	PDIP	Ν	20	20	RoHS & Non-Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74LS697N	Samples
SNJ54LS697J	ACTIVE	CDIP	J	20	20	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS697J	Samples

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

⁽³⁾ MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

⁽⁴⁾ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

⁽⁶⁾ Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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PACKAGE OPTION ADDENDUM

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

OTHER QUALIFIED VERSIONS OF SN54LS697, SN74LS697 :

Catalog : SN74LS697

Military : SN54LS697

NOTE: Qualified Version Definitions:

Catalog - TI's standard catalog product

• Military - QML certified for Military and Defense Applications



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5-Jan-2022

TUBE



*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	Τ (μm)	B (mm)
SN74LS697DW	DW	SOIC	20	25	507	12.83	5080	6.6
SN74LS697N	N	PDIP	20	20	506	13.97	11230	4.32

J (R-GDIP-T**) 14 LEADS SHOWN

CERAMIC DUAL IN-LINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- \triangle The 20 pin end lead shoulder width is a vendor option, either half or full width.



DW0020A



PACKAGE OUTLINE

SOIC - 2.65 mm max height

SOIC



NOTES:

- 1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M. 2. This drawing is subject to change without notice. 3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.43 mm per side.
- 5. Reference JEDEC registration MS-013.



DW0020A

EXAMPLE BOARD LAYOUT

SOIC - 2.65 mm max height

SOIC



NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



DW0020A

EXAMPLE STENCIL DESIGN

SOIC - 2.65 mm max height

SOIC



NOTES: (continued)

- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.



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